IGBT

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss.

Features

- Low Saturation Voltage using Trench with Field Stop Technology
- Low Switching Loss Reduces System Power Dissipation
- Soft Fast Reverse Recovery Diode
- Optimized for High Speed Switching
- 5 µs Short-Circuit Capability
- These are Pb-Free Devices

Typical Applications

- Solar Inverters
- Uninterruptable Power Supply (UPS)

ABSOLUTE MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|--|------------------|-------------|------|
| Collector-emitter voltage | V _{CES} | 600 | V |
| Collector current @ Tc = 25°C @ Tc = 100°C | I _C | 60 30 | A |
| Pulsed collector current, T _{pulse} limited by T _{Jmax} | I _{CM} | 120 | Α |
| Diode Forward Current @ T _C = 25°C @ T _C = 100°C | I _F | 60 30 | Α |
| Diode Pulsed Current T _{pulse} Limited by T _{Jmax} | I _{FM} | 120 | Α |
| Short–circuit withstand time V_{GE} = 15 V, V_{CE} = 300 V, $T_{J} \le +150^{\circ}C$ | t _{SC} | 5 | μs |
| Gate-emitter voltage Transient Gate Emitter Voltage (t _p = 5 μs, D < 0.010) | V _{GE} | ±20 ±30 | V |
| Power Dissipation @ Tc = 25°C @ Tc = 100°C | P _D | 250 67 | W |
| Operating junction temperature range | TJ | –55 to +150 | °C |
| Storage temperature range | T _{stg} | -55 to +150 | °C |
| Lead temperature for soldering, 1/8" from case for 5 seconds | T _{SLD} | 260 | °C |

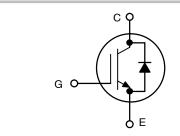
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

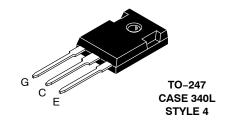


ON Semiconductor®

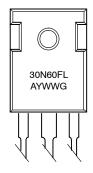
http://onsemi.com

30 A, 600 V **V_{CEsat}** = 1.65 **V**





MARKING DIAGRAM



= Assembly Location

= Year WW = Work Week = Pb-Free Package

ORDERING INFORMATION

| Device | Package | Shipping |
|---------------|---------------------|-----------------|
| NGTB30N60FLWG | TO-247 (Pb-Free) | 30 Units / Rail |

THERMAL CHARACTERISTICS

| Rating | Symbol | Value | Unit |
|--|----------------|-------|------|
| Thermal resistance junction-to-case, for IGBT | $R_{	heta JC}$ | 0.486 | °C/W |
| Thermal resistance junction-to-case, for Diode | $R_{	heta JC}$ | 1.06 | °C/W |
| Thermal resistance junction-to-ambient | $R_{	hetaJA}$ | 40 | °C/W |

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

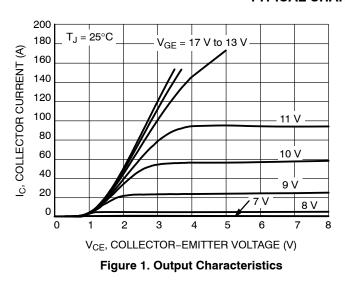
| Parameter | Test Conditions | Symbol | Min | Тур | Max | Unit |
|---|--|----------------------|----------|-------------|----------|------|
| STATIC CHARACTERISTIC | | | | • | | |
| Collector-emitter breakdown voltage, gate-emitter short-circuited | $V_{GE} = 0 \text{ V}, I_{C} = 500 \mu\text{A}$ | V _{(BR)CES} | 600 | - | _ | V |
| Collector-emitter saturation voltage | V _{GE} = 15 V, I _C = 30 A V _{GE} = 15 V, I _C = 30 A, T _J = 150°C | V _{CEsat} | 1.4 - | 1.65 2.0 | 1.9 - | ٧ |
| Gate-emitter threshold voltage | $V_{GE} = V_{CE}, I_{C} = 200 \mu A$ | V _{GE(th)} | 4.5 | 5.5 | 6.5 | V |
| Collector-emitter cut-off current, gate- emitter short-circuited | V _{GE} = 0 V, V _{CE} = 600 V V _{GE} = 0 V, V _{CE} = 600 V, T _J = 150°C | I _{CES} | <u>-</u> | - - | 0.2 2 | mA |
| Gate leakage current, collector-emitter short-circuited | V _{GE} = 20 V , V _{CE} = 0 V | I _{GES} | - | - | 100 | nA |
| DYNAMIC CHARACTERISTIC | | | | • | • | |
| Input capacitance | | C _{ies} | - | 4200 | _ | pF |
| Output capacitance | $V_{CE} = 20 \text{ V}, V_{GE} = 0 \text{ V}, f = 1 \text{ MHz}$ | C _{oes} | - | 170 | - | |
| Reverse transfer capacitance |] | C _{res} | - | 110 | - | |
| Gate charge total | | Q_g | - | 170 | - | nC |
| Gate to emitter charge | V _{CE} = 480 V, I _C = 30 A, V _{GE} = 15 V | Q _{ge} | - | 34 | - | |
| Gate to collector charge | | Q _{gc} | - | 83 | - | |
| SWITCHING CHARACTERISTIC, INDUC | TIVE LOAD | | | | | |
| Turn-on delay time | | t _{d(on)} | _ | 83 | _ | ns |
| Rise time |] | t _r | _ | 31 | - | 1 |
| Turn-off delay time | T _J = 25°C | t _{d(off)} | _ | 170 | - | |
| Fall time | $V_{CC} = 400 \text{ V}, I_{C} = 30 \text{ A}$ $R_{q} = 10 \Omega$ | t _f | - | 80 | - | |
| Turn-on switching loss | V _{GE} = 0 V/ 15 V | E _{on} | - | 0.7 | - | mJ |
| Turn-off switching loss |] | E _{off} | - | 0.28 | - | |
| Total switching loss |] | E _{ts} | - | 0.98 | - | |
| Turn-on delay time | | t _{d(on)} | - | 81 | - | ns |
| Rise time | | t _r | - | 32 | - | |
| Turn-off delay time | T _J = 150°C | t _{d(off)} | - | 180 | - | |
| Fall time | $V_{CC} = 400 \text{ V, } I_{C} = 30 \text{ A}$ $R_{G} = 10 \Omega$ | t _f | - | 110 | - | |
| Turn-on switching loss | $R_g = 10 \Omega$ $V_{GE} = 0 \text{ V} / 15 \text{ V}$ | E _{on} | - | 0.82 | - | mJ |
| Turn-off switching loss | | E _{off} | - | 0.63 | - | |
| Total switching loss |] | E _{ts} | - | 1.45 | - | |

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

| Parameter Test Conditions | | Symbol | Min | Тур | Max | Unit |
|---------------------------|---|------------------|-----------|------------|-----------|------|
| DIODE CHARACTERISTIC | | | | | | |
| Forward voltage | $V_{GE} = 0 \text{ V, I}_{F} = 30 \text{ A}$ $V_{GE} = 0 \text{ V, I}_{F} = 30 \text{ A, T}_{J} = 150^{\circ}\text{C}$ | V _F | 1.45 - | 1.9 2.0 | 2.35 - | V |
| Reverse recovery time | T _{.I} = 25°C | t _{rr} | - | 72 | _ | ns |
| Reverse recovery charge | $I_F = 30 \text{ Å}, V_R = 200 \text{ V}$ | Q _{rr} | - | 0.25 | - | μC |
| Reverse recovery current | di _F /dt = 200 A/μs | I _{rrm} | - | 6 | _ | Α |

TYPICAL CHARACTERISTICS

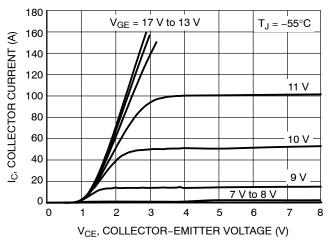
180



 $T_J = 150^{\circ}C$ 160 Ic, COLLECTOR CURRENT (A) 140 120 100 11 V 80 10 V 60 40 9 V 20 8 V 0 0 V_{CE}, COLLECTOR-EMITTER VOLTAGE (V)

V_{GE} = 17 V to 13 V

Figure 2. Output Characteristics



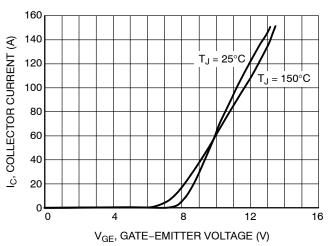
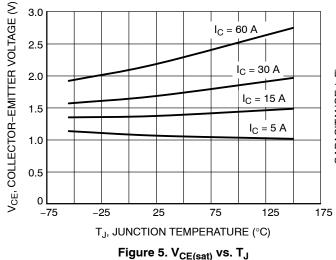


Figure 3. Output Characteristics

Figure 4. Typical Transfer Characteristics



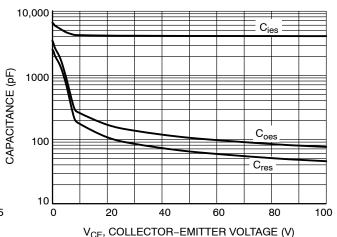
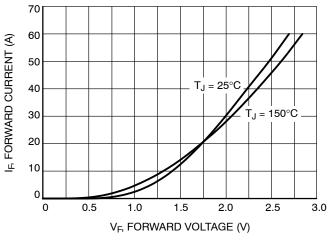


Figure 6. Typical Capacitance

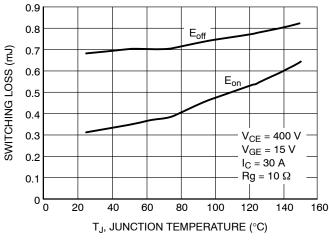
TYPICAL CHARACTERISTICS



20 V_{GE}, GATE-EMITTER VOLTAGE (V) V_{CE} = 480 V 15 10 5 0 25 50 75 100 125 150 175 200 Q_G, GATE CHARGE (nC)

Figure 7. Diode Forward Characteristics

Figure 8. Typical Gate Charge



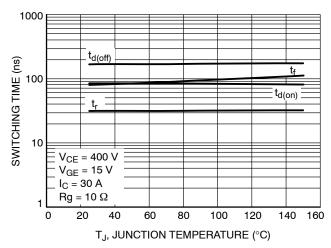
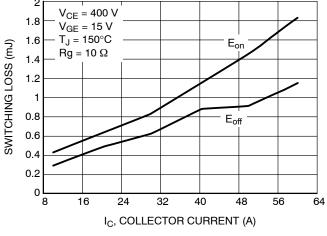


Figure 9. Switching Loss vs. Temperature

Figure 10. Switching Time vs. Temperature



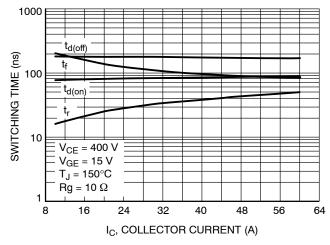
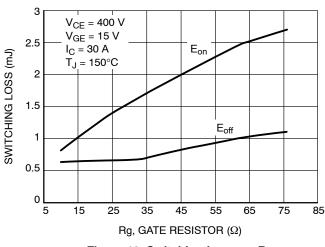


Figure 11. Switching Loss vs. I_C

Figure 12. Switching Time vs. I_C

TYPICAL CHARACTERISTICS



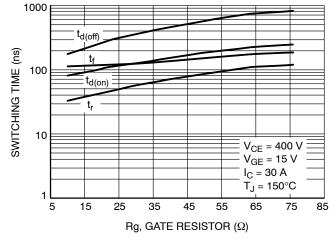
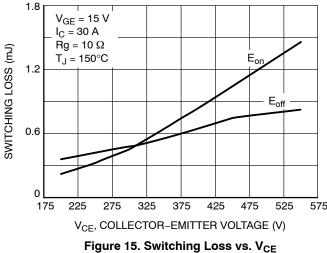


Figure 13. Switching Loss vs. Rg

Figure 14. Switching Time vs. Rg





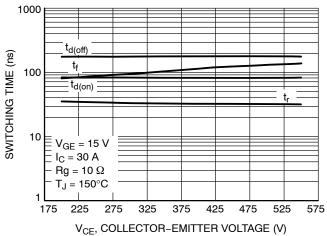


Figure 16. Switching Time vs. V_{CE}

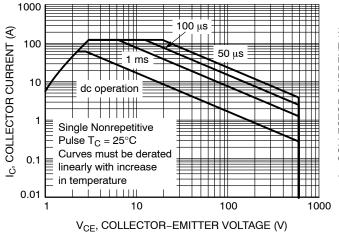


Figure 17. Safe Operating Area

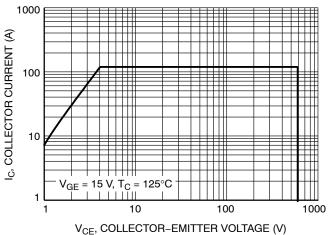


Figure 18. Reverse Bias Safe Operating Area

TYPICAL CHARACTERISTICS

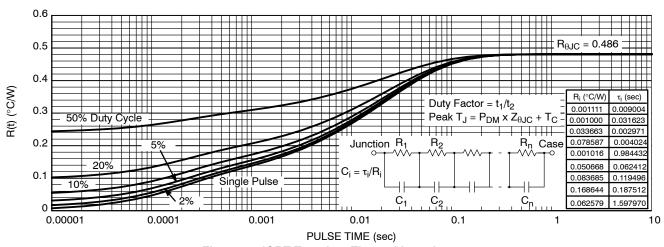


Figure 19. IGBT Transient Thermal Impedance

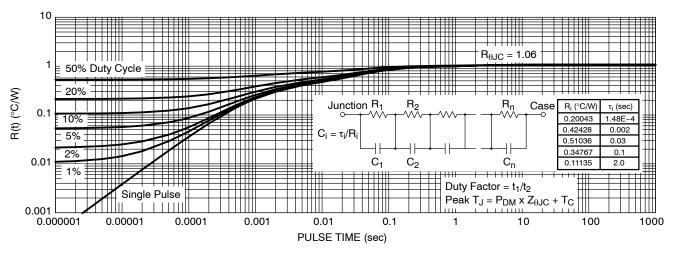


Figure 20. Diode Transient Thermal Impedance

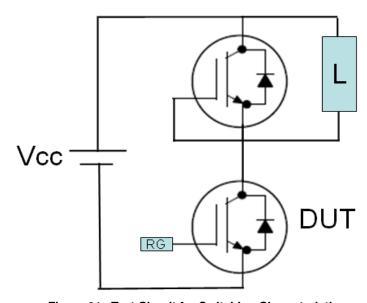


Figure 21. Test Circuit for Switching Characteristics

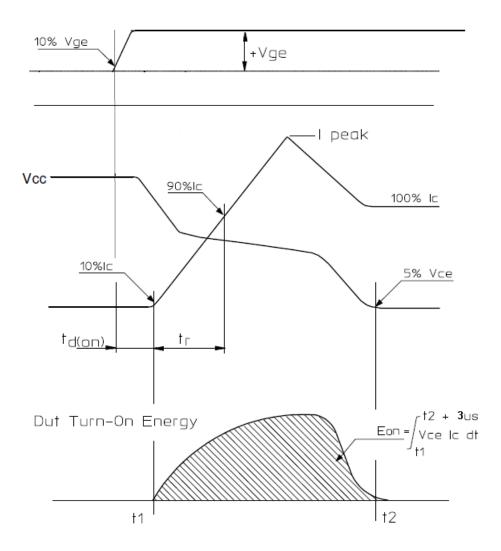


Figure 22. Definition of Turn On Waveform

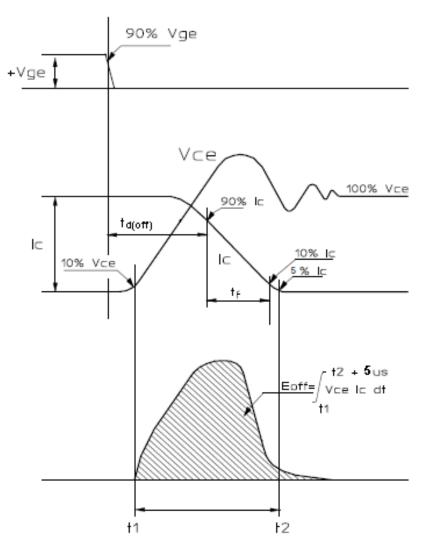
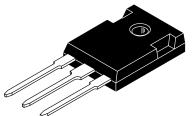


Figure 23. Definition of Turn Off Waveform





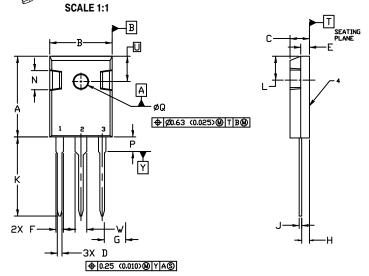
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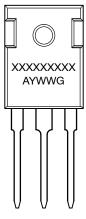
NOTES

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETER

| | MILLIMETERS | | INC | HES |
|-----|-------------|-------|-----------|-------|
| DIM | MIN. | MAX. | MIN. | MAX. |
| Α | 20.32 | 21.08 | 0.800 | 0.830 |
| В | 15.75 | 16.26 | 0.620 | 0.640 |
| С | 4.70 | 5.30 | 0.185 | 0.209 |
| D | 1.00 | 1.40 | 0.040 | 0.055 |
| Ε | 1.90 | 2.60 | 0.075 | 0.102 |
| F | 1.65 | 2.13 | 0.065 | 0.084 |
| G | 5.45 BSC | | 0.215 BSC | |
| Н | 1.50 | 2.49 | 0.059 | 0.098 |
| J | 0.40 | 0.80 | 0.016 | 0.031 |
| К | 19.81 | 20.83 | 0.780 | 0.820 |
| L | 5.40 | 6.20 | 0.212 | 0.244 |
| N | 4.32 | 5.49 | 0.170 | 0.216 |
| Р | | 4.50 | | 0.177 |
| Q | 3.55 | 3.65 | 0.140 | 0.144 |
| U | 6.15 BSC | | 0.242 BSC | |
| W | 2.87 | 3.12 | 0.113 | 0.123 |



GENERIC MARKING DIAGRAM*



| STYLE 1: | |
|----------|--------|
| PIN 1. | GATE |
| 2. | DRAIN |
| 3. | SOURCE |
| 4. | DRAIN |

STYLE 2:
PIN 1. ANODE
2. CATHODE (S)
3. ANODE 2
4. CATHODES (S)

STYLE 3:
PIN 1. BASE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

STYLE 4:
PIN 1. GATE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

XXXXX = Specific Device Code A = Assembly Location

Y = Year
WW = Work Week
G = Pb-Free Package

 STYLE 5:
 STYLE 6:

 PIN 1. CATHODE
 PIN 1. MAIN TERMINAL 1

 2. ANODE
 2. MAIN TERMINAL 2

 3. GATE
 3. GATE

 4. ANODE
 4. MAIN TERMINAL 2

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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